# Development of Metallic Slurry Coatings

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### Outline

- Background: Advanced materials for fossil energy applications
- Problem: Limitations of materials in aggressive environments
- Objective: Develop & fabricate low-cost protective systems
- Slurry processing of protective coating materials
  - -Why coat metal systems?
  - Progress
- Research Highlights
- Future Research
- Acknowledgements



#### Advanced Materials for Fossil Energy Applications

- Temperatures up to 1550 °C
- Aggressive species include:
  - Sulfur
  - Nitrogen
  - Trace heavy metals
  - Alkali salts
  - Steam
  - Molten slag
- Protection systems will be necessary to extend lifetimes of materials in these environments
- The efforts in this project are aimed at developing a cost effective process for applying potentially protective coating systems



### Objectives

- The development of low cost coatings for protection of corrosion and/or environmentally sensitive metallic substrates.
  - Dip coating selected as process
  - Work will initially focus on ferritic martensitic alloys
  - Aluminum diffusion in T91 for demonstration
    - Commercial metal systems as substrate material
    - Aluminum slurries (iron aluminide) as coating material

### Key Issues

- Apply basic colloid principles developed in ceramic systems to the metallic systems
- Collaboration with other FE-ARM projects to ensure property relationships are addressed



## Why Coat Metallic Systems

- Coal-fired power plant efficiency improvements requires increase in steam temperature and pressure
- Extensive steam side oxidation an issue for 9%Cr ferritic/martensitic alloys
- Aluminide coatings can significantly reduce the oxidation rate of ferritic and austenitic steels in exhaust/steam environment



# Why Coat Metallic Systems (2)

#### Potential slurry coating advantages:

- Substrate alloy can be customized for properties other than corrosion resistance
- Reduced processing costs
- Alternative substrate processing approaches possible,
   i.e., lower annealing temperatures, times, etc...

#### Challenges:

- Physical, chemical and mechanical differences between substrate and coating can lead to detrimental interaction thus limiting lifetimes
- Others already "dip" coating but lag in understanding underlying principles affecting substrate/coating interface on resulting property lifetimes



## Historic Coating Perspectives



Samurai Sword (Hamon-refractory clay) 800 A.D.



**Niello Armor** (metal sulfides) 1550 A.D.

## Present Day Coating Perspectives

- Pint, Haynes/ORNL
  - CVD of model coatings on Fe-9Cr-1Mo
- Zhang/Tennessee Technological University
  - Aluminide pack cementation and CVD coatings
- Agüero/INTA (Spain)
  - Al slurry/brush coatings (commercial source)
     on P92, P22, P23 alloys
- "Commercial Sources"
  - Sermatech (slurry aluminizing)



### Selection of Metallic System Based on Short Term and Long Term Benefits

- Short term ferritic martensitic alloys:
  - Development efforts have improved mechanical behavior while decreasing alloy's resistance to steam oxidation
  - Commercial coating systems with known HT oxidation resistance have been tested on these alloys and early results are promising
  - Al slurries will be developed using colloidal techniques, and slurries will be applied to T91 alloy substrates
  - Coatings will be heat treated at varying temperatures to determine processing parameters (potential joining metal forming and coating steps)
  - Environmental exposure/testing and creep testing will be completed on coated alloys
- Long term Austenitic Alloys & Ni-based superalloys:
  - Knowledge gained from the development of coatings for ferritic martensitic alloys will be applied here



### Putting Scientific Principles to Practice

- Applied colloidal principles to develop slurry formulation
  - Surface Charge (stability and dispersant selection)
  - Rheology (flow behavior as a function of solids loadings, solvent selection and dispersant concentration)
  - Effect of interface wetting and interactions
- Evaluate processing-property relationships
  - Solids concentrations and processing temperatures effect upon Al diffusion or aluminide phase formation



### Where Did We Leave Off Last?

#### Aqueous coating approach was feasible

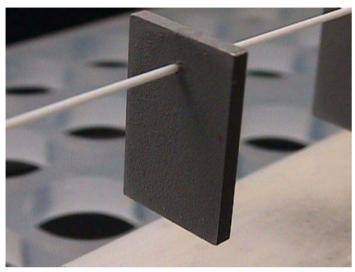
- Dispersant identified
- Al solids loadings identified (5 vol%)
- Flow behavior established for effective dipping and coating
- Wetting angle characterized as a function of processing conditions (water and solids)

### Sintering study completed

- 750°C/ 2 hours in argon formed "islands"
- 1050°C/ 2 hours in argon formed uniform infiltration across substrate
- Large grains evident at surface of 1050°C condition
- Formation of "unknown" material between diffusion zone and substrate

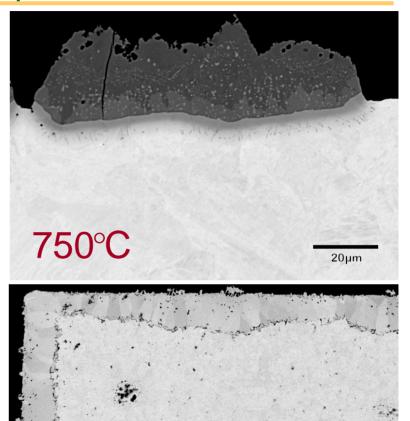


### Formation of Coating is Dependent Upon Sintering Temperature



As Coated Surfaces "Uniform"

- 5% Al Aqueous Slurry on T 91 Substrate
- Sintered at temperature for 2 hours in argon

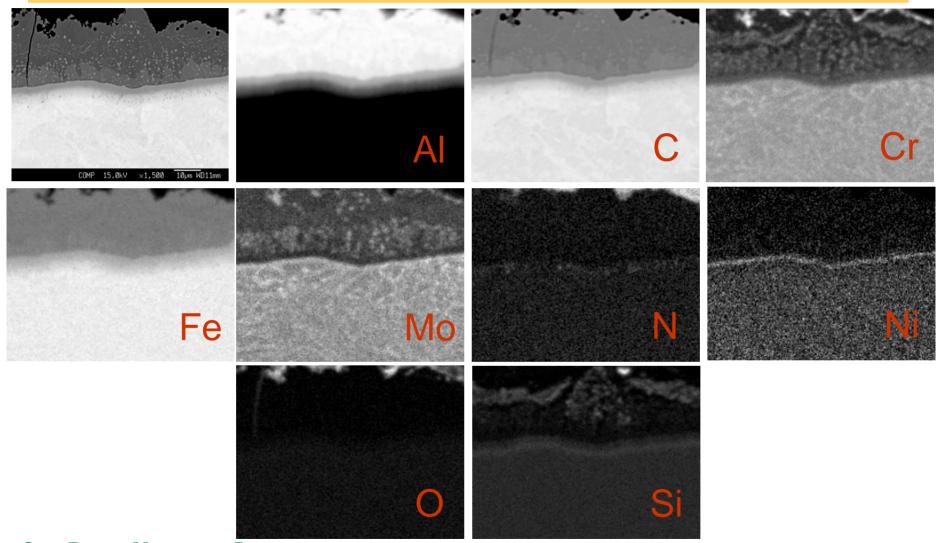






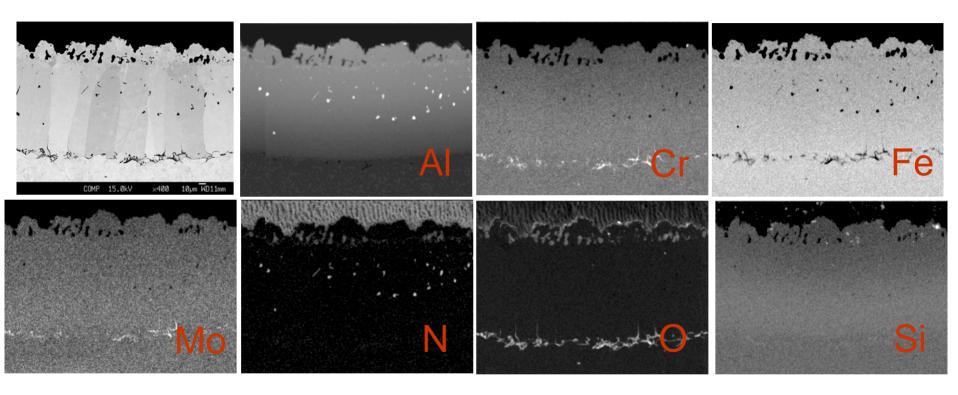
100µm

# Initial Al Diffusion; Migration of Mo, N and Ni to Interface (750°C, 2 hrs/Argon)





# Al Diffusion Zone More Uniform at 1050°C (2 hrs/Argon)



Oxygen at interface: Is it a result of an aqueous slurry or other processing variable (Al powder, contamination)?
Should an organic slurry be evaluated?



## Going Green: why organic

- No hydroxide formation at Al/alumina surfaces in solution
  - Potential source of oxygen at interface
- Higher solids loadings possible = more material/less "islands"
  - Al solids loadings experiments (5, 10, 20 and 25 vol%)
  - Flow behavior established for effective dipping and coating
  - Wetting angle characterized
- Sintering study repeated
  - 350°C/ 2 hours in argon formed "discrete particles"
  - 750°C/ 2 hours in argon formed more uniform infiltration across substrate; cracking evident
  - 1050°C/ 2 hours in argon formed large grains; more defected than aqueous counterpart

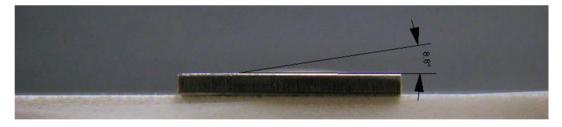


### Wetting Behavior: Aqueous Vs. Organic

Slurry (%Al)	Contact Angle
5% – DI H <sub>2</sub> O	33.91
5% - Organic	0
10% - Organic	~ 2-5
20% - Organic	8.8
25% - Organic	39.3

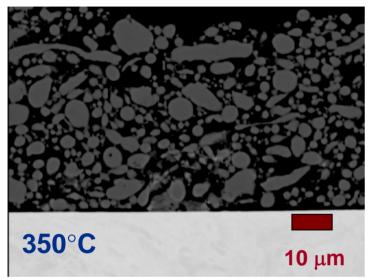


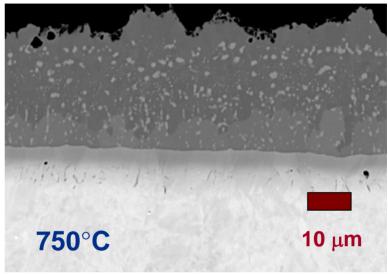
 $5\% - DIH_2O$ 

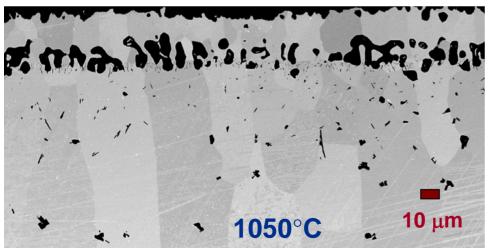


20% - Organic

# Organic Al Slurry Microstructure Formation as a Function of Temperature "Similar" to Aqueous Systems at High Solids Loadings ( > 20 vol% Al)





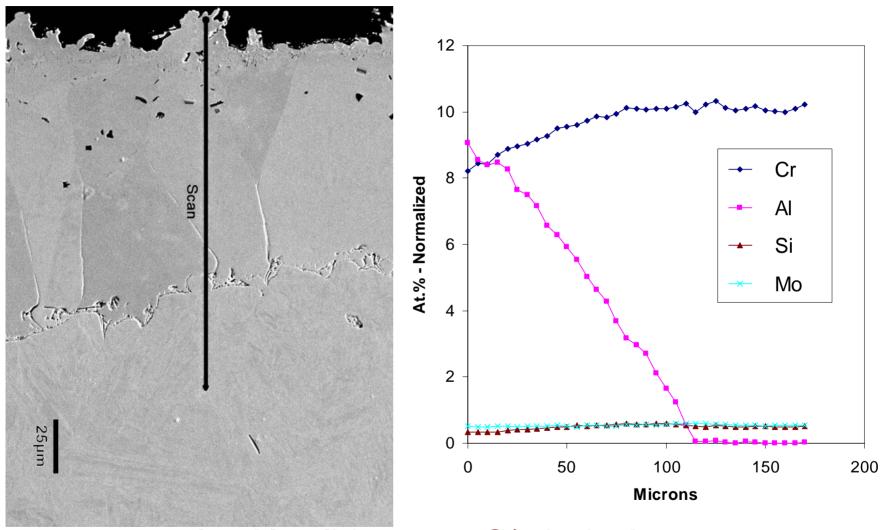


•750°C: wetting behavior uniform at 20 vol% Al loading (ie., no islands), some cracking evident
•1050°C: formation of porosity

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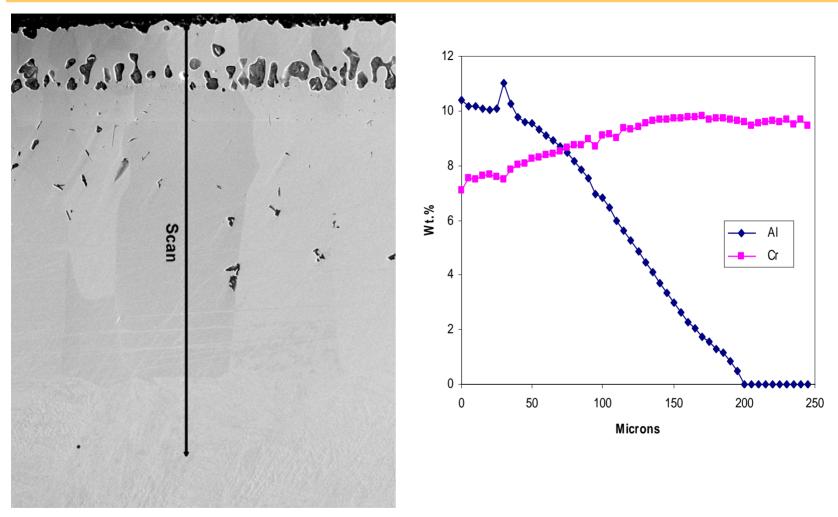
### Is Adequate Al Diffusion Occurring?



5 vol% Al solids, 1050°C/2 hr in Argon



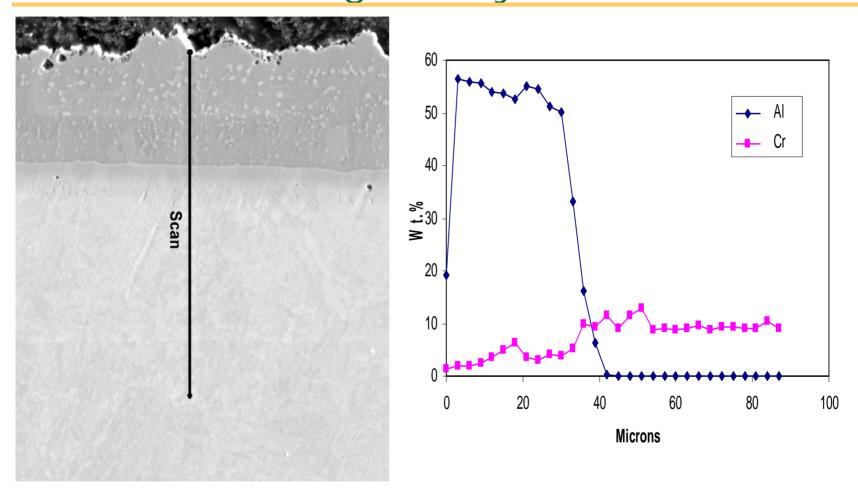
### Al Diffusion Profiles Similar at 1050°C



20 organic vol% Al solids, 1050°C/2 hr in Argon



# Al Concentration Higher at Lower Temp for Organic System

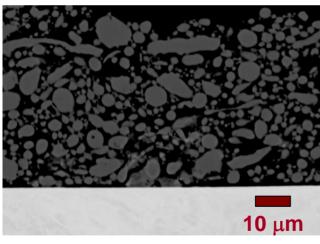


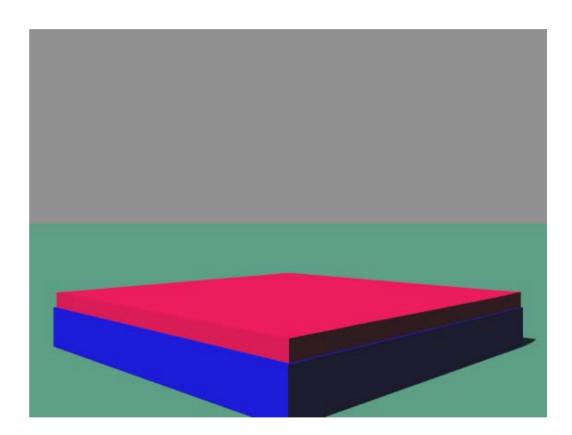
20 organic vol% Al solids, 750°C/2 hr in Argon



# Removal of Organic Species Occurs Below Al Melt Temperature





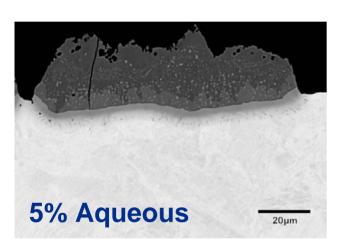


350°C/2 hours in argon

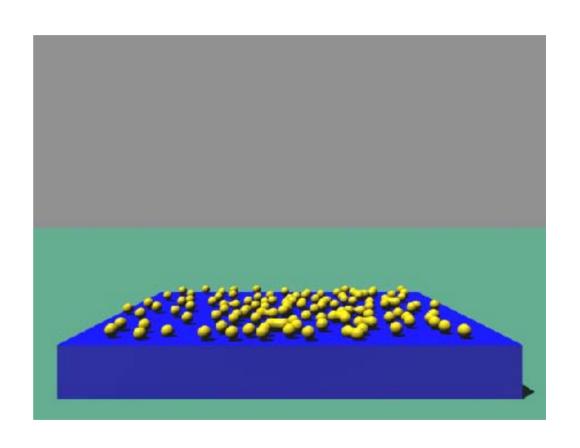




# Island Formation Resulting from Wetting of Al melt at Temperature

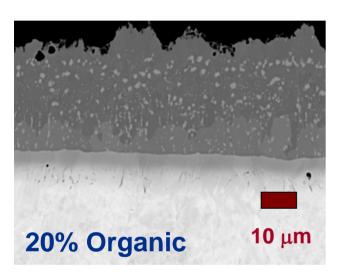


750°C/2 hours in argon

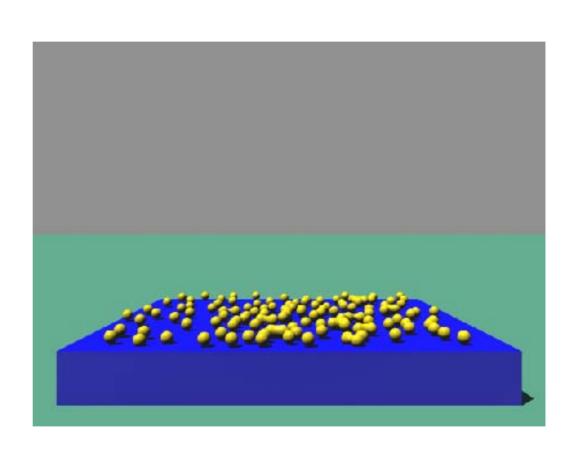




# Desired Wetting Behavior Will Enable Uniform Al Diffusion



750°C/2 hours in argon







## Summary of Results

- Al slurry microstructures are dependent upon
  - Slurry variables (solvent, solids loading, wetting)
  - Sintering conditions (temperature)
- Organic Al slurries optimized for higher solids loadings and improved wetting at room temperature
- Improved AI diffusion is feasible with processing controls

### **Future Work**

- Evaluation of slurry coating and process efficacy of metallic-based systems
  - Refine Al diffusion profiles in slurry systems to meet model predictions and CVD results
  - Test in simulated fossil environments
- Environmental and mechanical testing to obtain confirmation of performance and feedback
- Coordinate effort with metals/corrosion/oxidation projects to maintain relevancy

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# Questions?



### Previous Ceramic Accomplishments

- Demonstrated feasibility and flexibility of process
  - Established "generic" process parameters
- Reduced sintering temperatures to minimize damage to substrate



Rare earth silicate coating on a complexshaped component (NT154 Si<sub>3</sub>N<sub>4</sub> Blade)

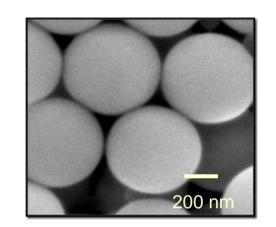
- •The process is flexible, i.e., it can be modified to incorporate a wide range of ceramic particles (e.g., mullite, BSAS, zirconia, rare-earth silicates and disilicates, aluminates, and aluminosilicates) and solvents (e.g., aqueous and organic)
  - Complex-shaped components to be coated are dipped into a slurry (ceramic particles suspended in a solvent medium).
  - As-dipped coatings are dried and heat treated at elevated temperatures to promote densification
  - Can be used as a patch for damaged coatings
  - Resultant coating quality depends upon slurry rheology and wetting behavior



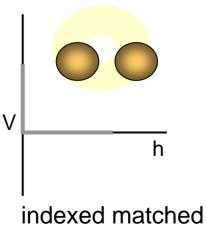
### **Tailoring Interactions Between Colloidal Building Blocks**

#### Colloidal particles --> basic "building blocks"

 must control interparticle forces to tailor structure, rheological properties, and drying

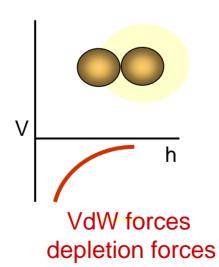


#### Hard sphere

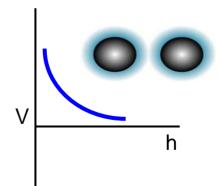


highly screened

**Attractive** 



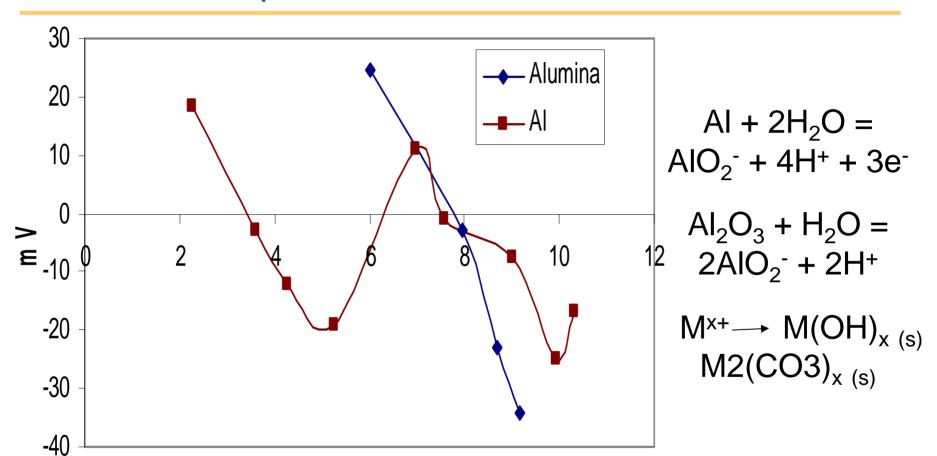
**Soft Sphere** 



steric-stabilized charge-stabilized



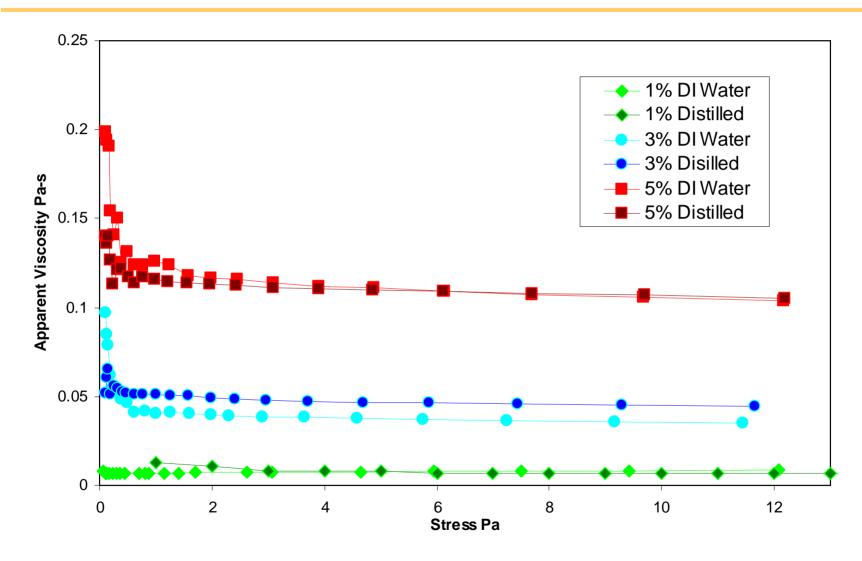
## Can An Aqueous Solvent Be Utilized?



pH Polyacrylic acid is a potential dispersant



### Viscosity Increases With Increasing Al Content





# Al Solids and Contamination Can Alter Wetting Behavior of Slurry

Slurry (%AI)	Contact Angle
1% – DI H <sub>2</sub> O	25.21
1% – Dist H <sub>2</sub> O	41.52
5% – DI H <sub>2</sub> O	33.91
5% – Dist H <sub>2</sub> O	57.39



Al slurry droplet on T91 substrate



# Elemental Diffusion Occurring at 750°C (2 hrs/Argon)

